



US00D812012S

(12) **United States Design Patent**  
**Zhu**

(10) **Patent No.:** **US D812,012 S**  
(45) **Date of Patent:** **\*\* Mar. 6, 2018**

(54) **CONDUCTIVE PLATE**

(71) Applicant: **SHANUTECH (SHANGHAI) CO., LTD.**, Shanghai (CN)

(72) Inventor: **Wenting Zhu**, Shanghai (CN)

(73) Assignee: **SHANUTECH (SHANGHAI) CO., LTD.**, Shanghai (CN)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/572,433**

(22) Filed: **Jul. 28, 2016**

(51) **LOC (11) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/146**

(58) **Field of Classification Search**  
USPC ..... D13/128, 129, 130, 131, 132, 133, 146,  
D13/147, 154, 182, 184, 199  
CPC ..... H01R 24/00; H01R 24/78; H01R 25/14;  
H01R 25/142; H01R 25/16; H01R 25/162  
See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

D253,887 S \* 1/1980 Turner ..... D13/177  
D343,385 S \* 1/1994 Sachs ..... D13/154

D443,160 S \* 6/2001 Ernst ..... D6/553  
D688,630 S \* 8/2013 Chapman ..... D13/154  
D743,897 S \* 11/2015 Krivonak ..... D13/147  
D743,899 S \* 11/2015 Murphy ..... D13/147  
D743,900 S \* 11/2015 Murphy ..... D13/147

\* cited by examiner

*Primary Examiner* — Daniel Bui

(74) *Attorney, Agent, or Firm* — Metis IP LLC

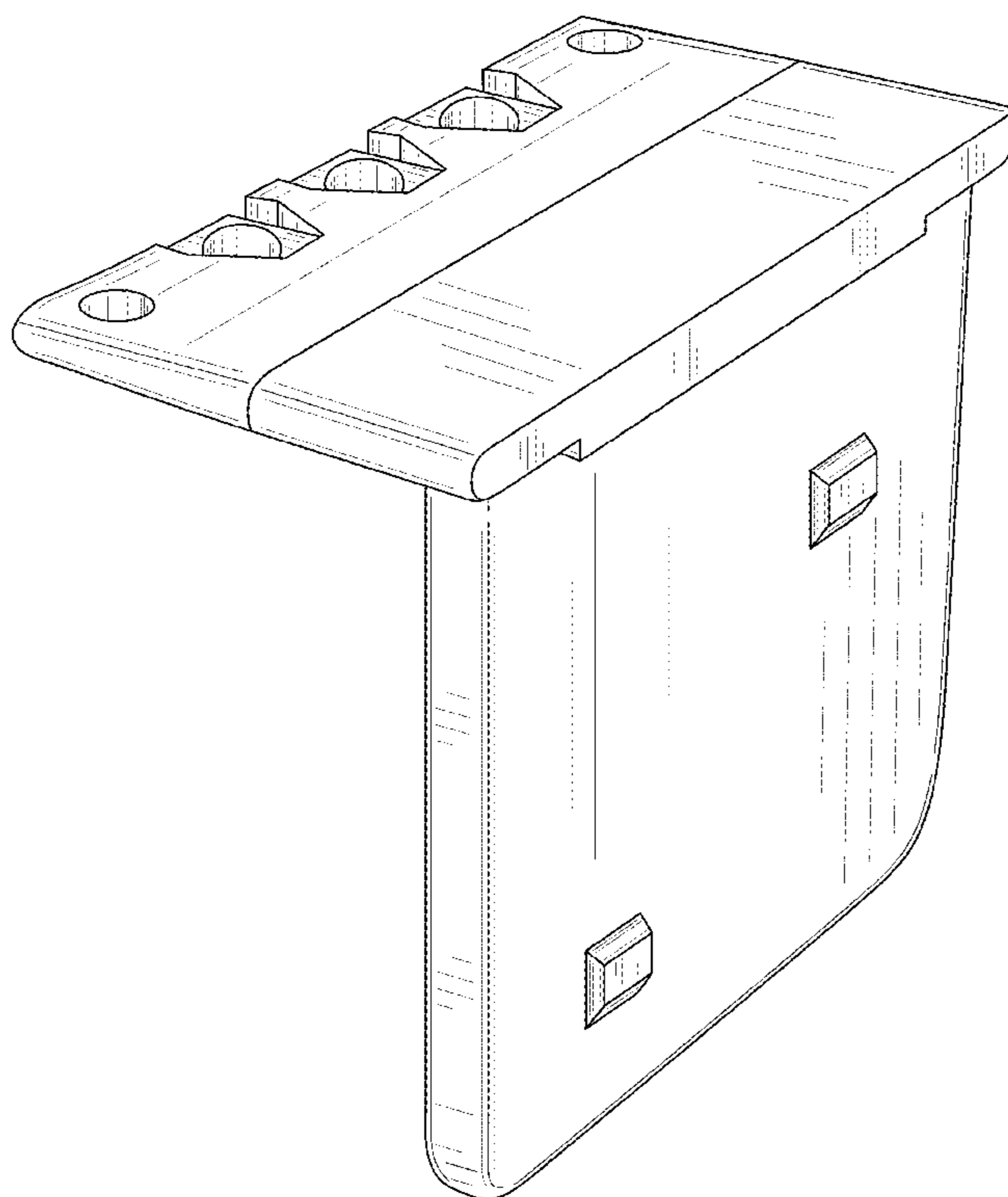
(57) **CLAIM**

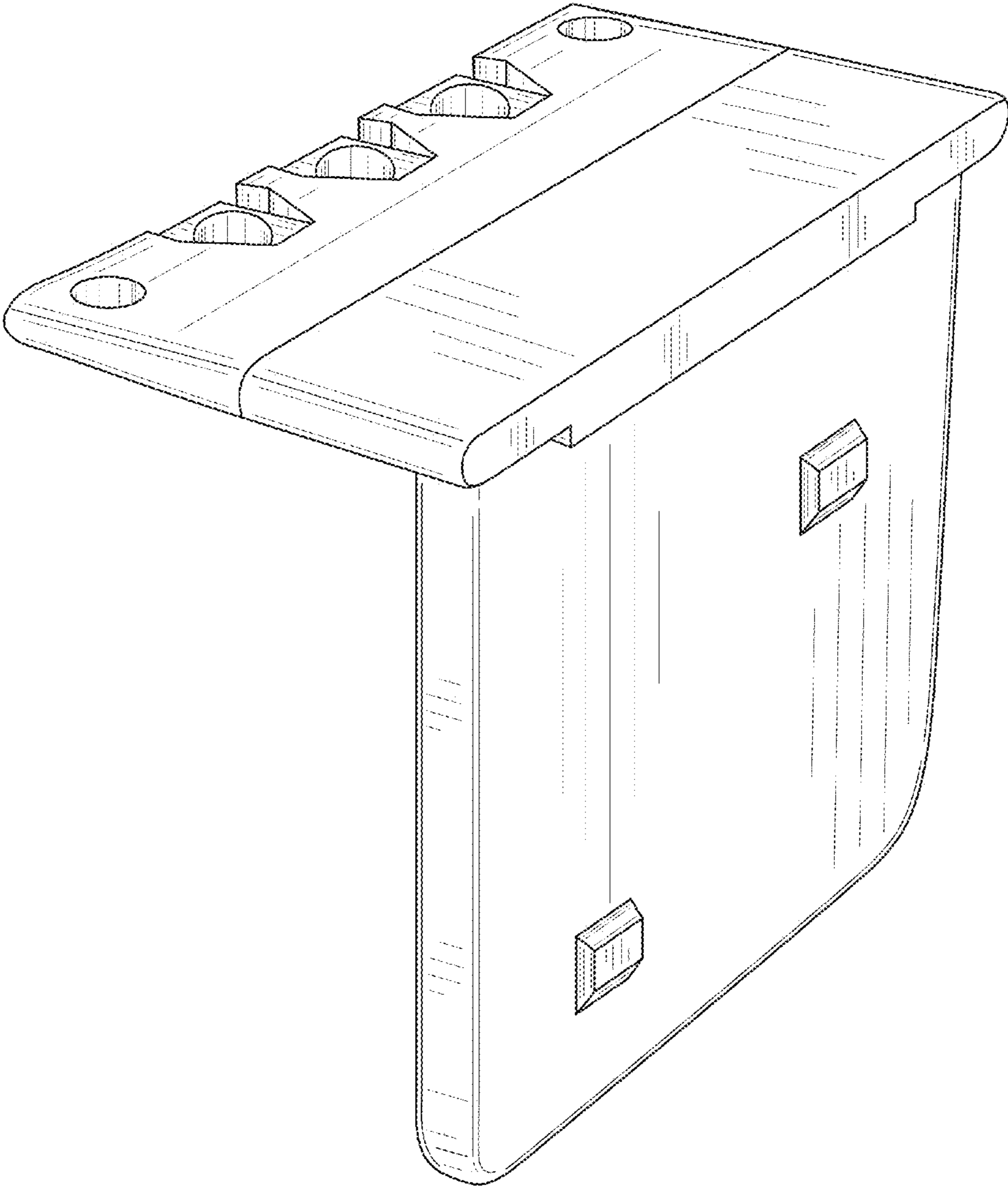
The ornamental design for a conductive plate, as shown and described.

**DESCRIPTION**

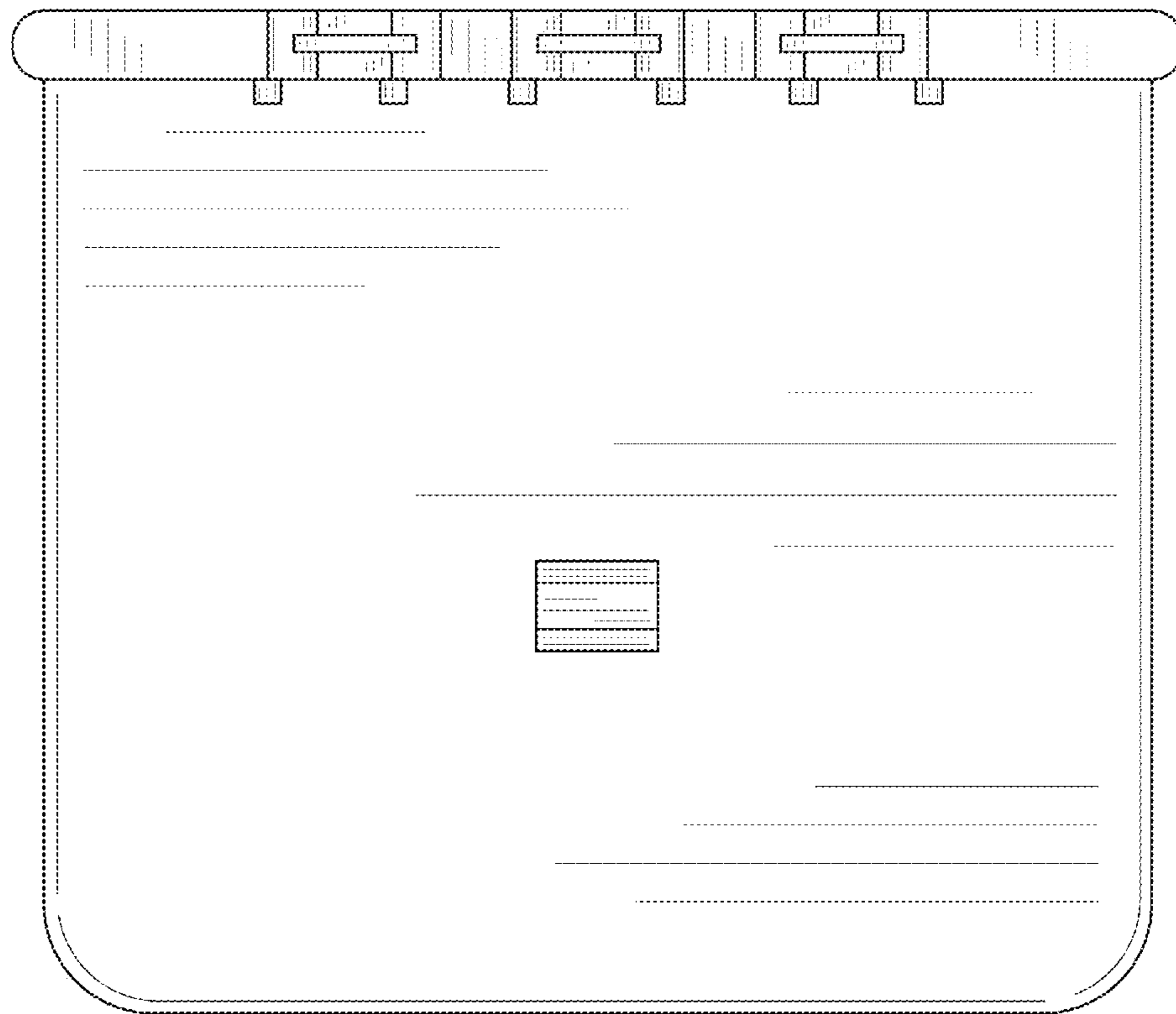
FIG. 1 is a perspective view of a conductive plate showing my new design;  
FIG. 2 is a front view thereof;  
FIG. 3 is a rear view thereof;  
FIG. 4 is a right view thereof;  
FIG. 5 is a left view thereof;  
FIG. 6 is a top view thereof; and,  
FIG. 7 is a bottom view thereof.

**1 Claim, 7 Drawing Sheets**

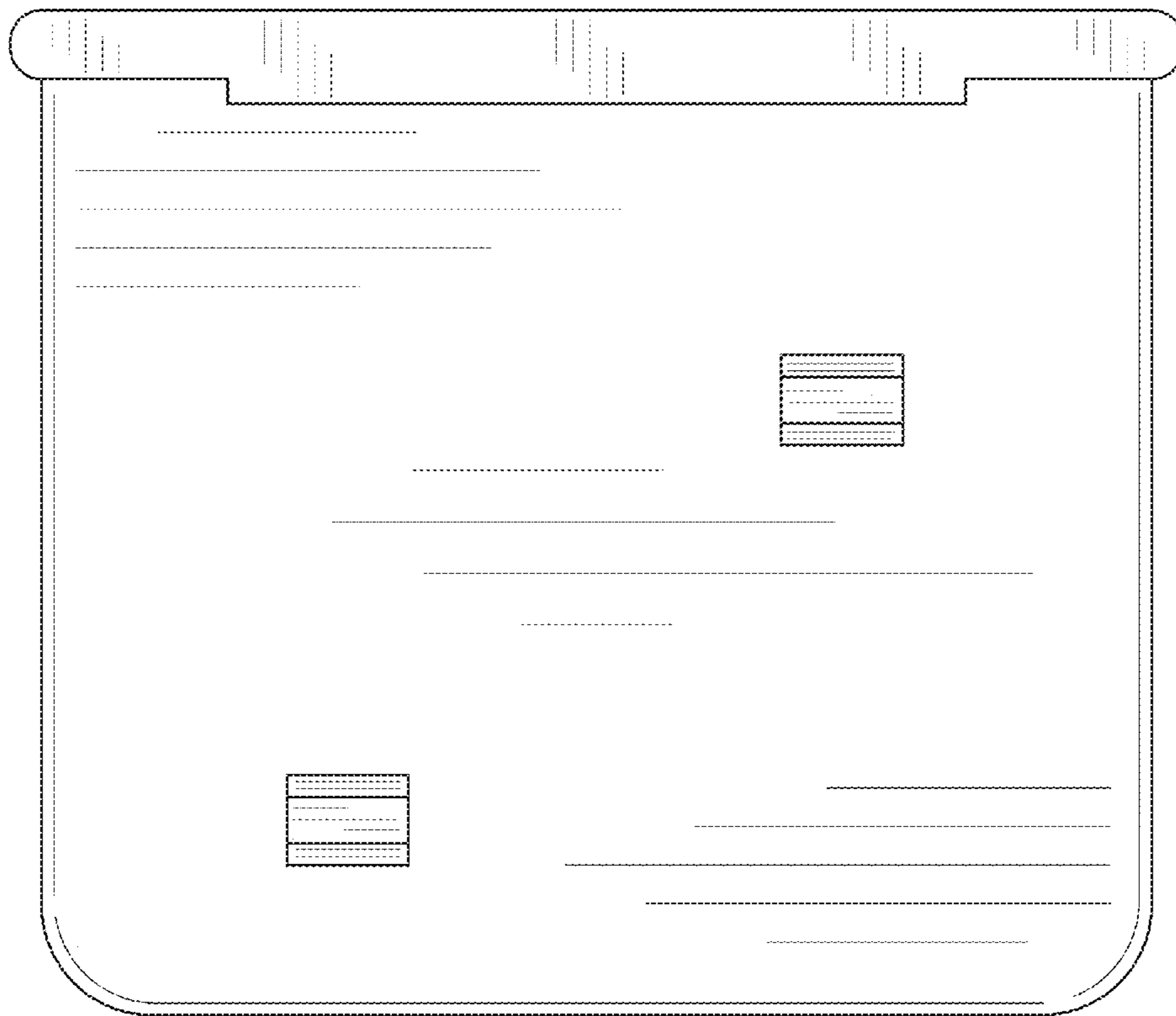




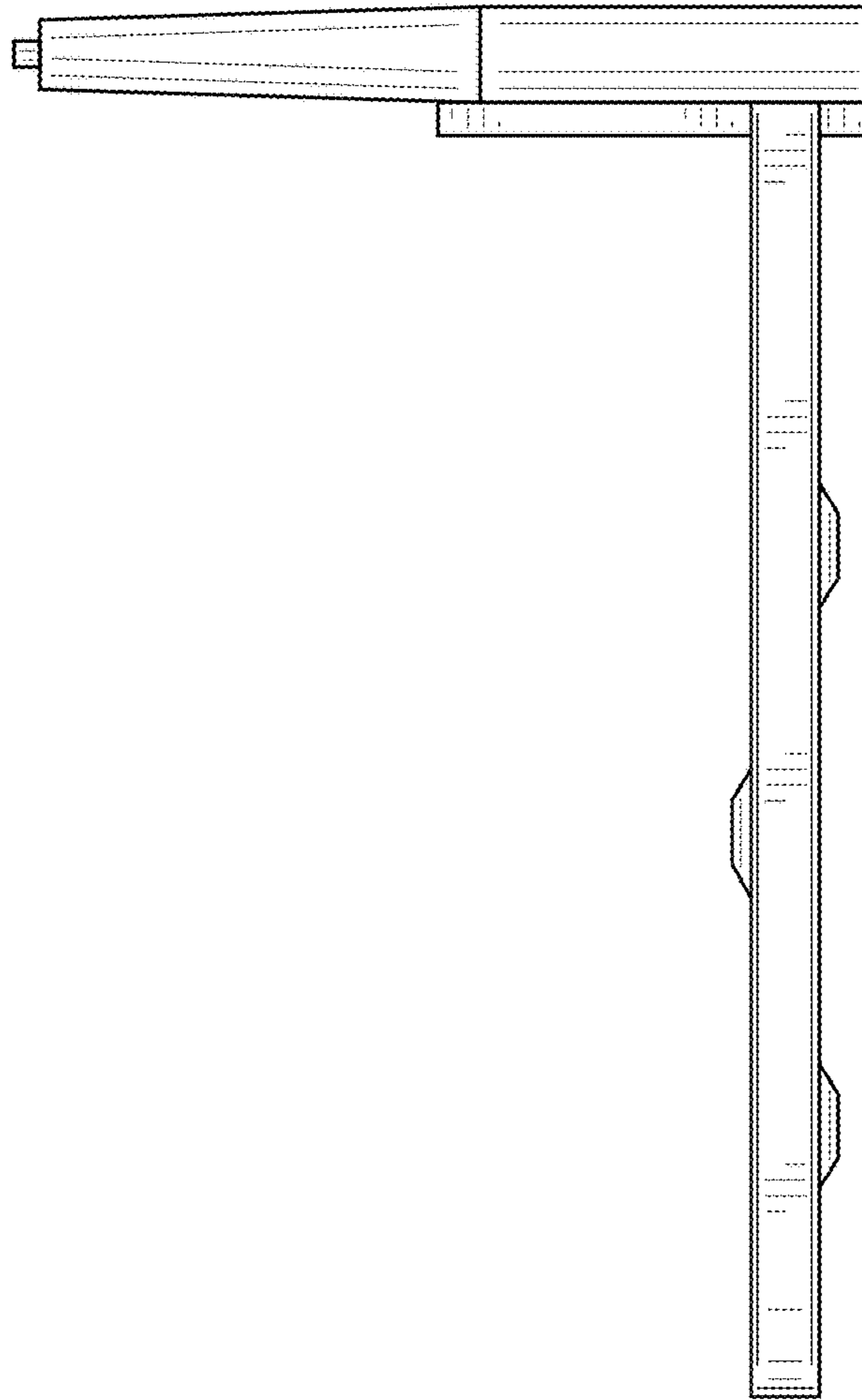
**FIG. 1**



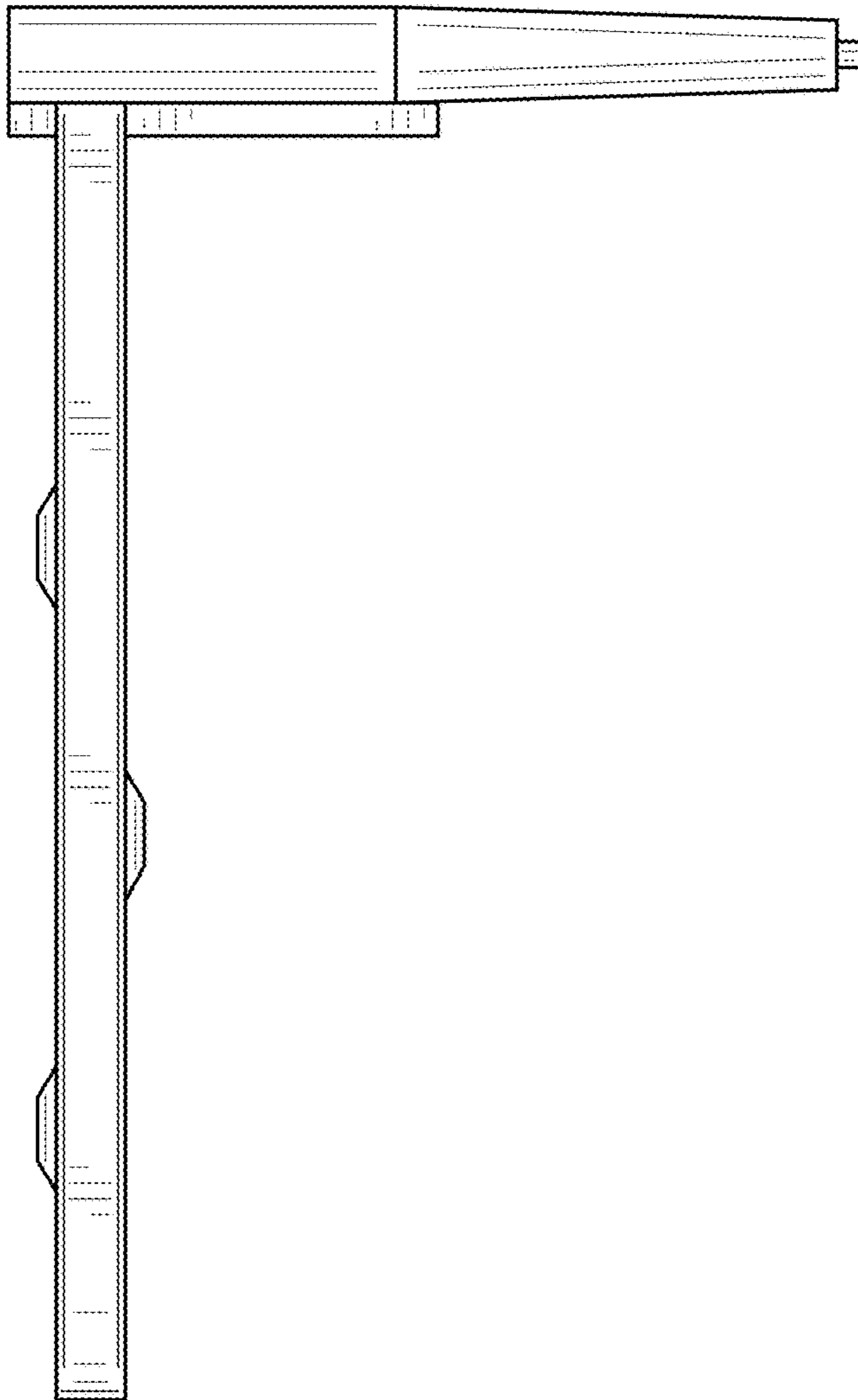
**FIG. 2**



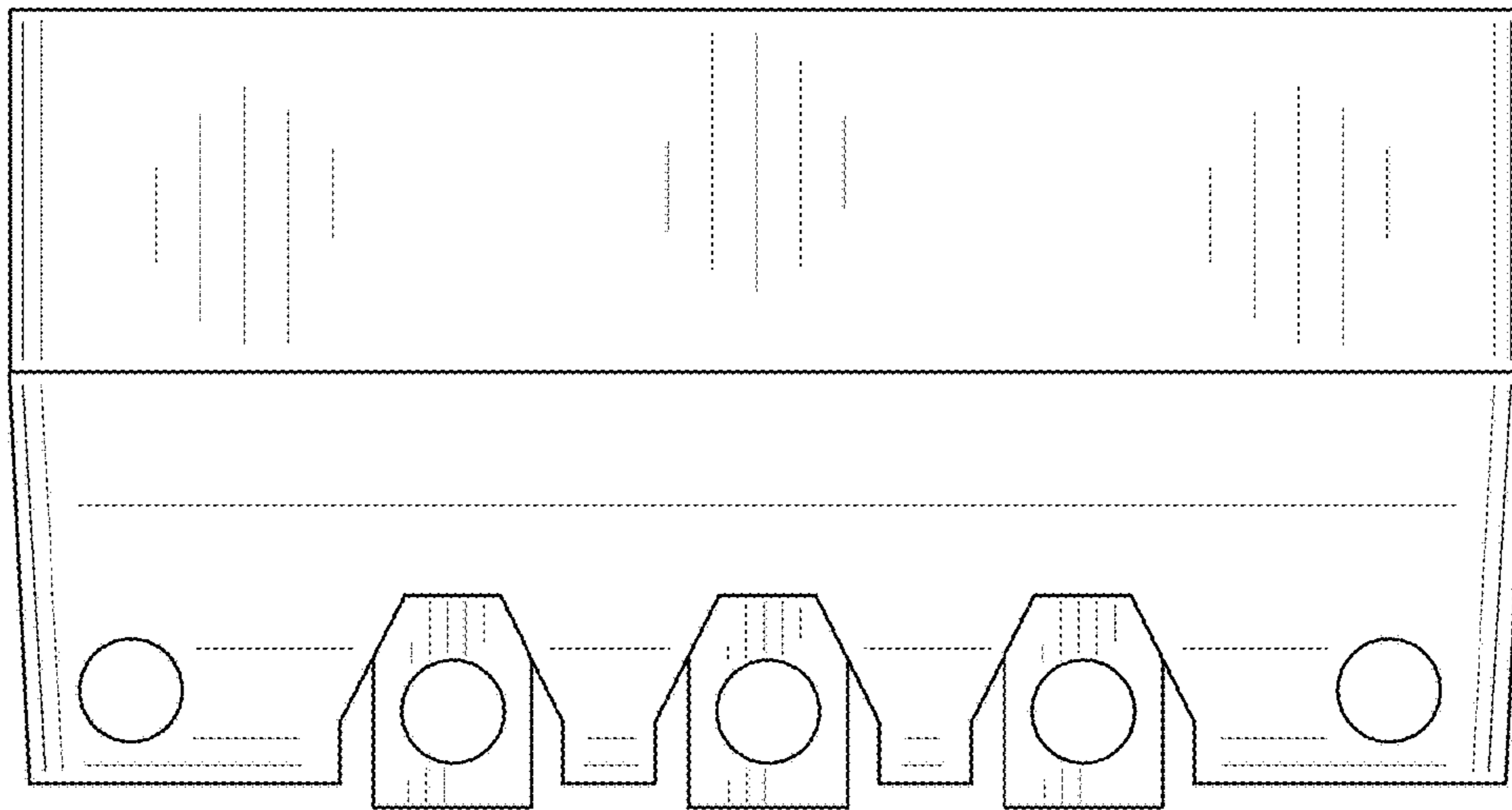
**FIG. 3**



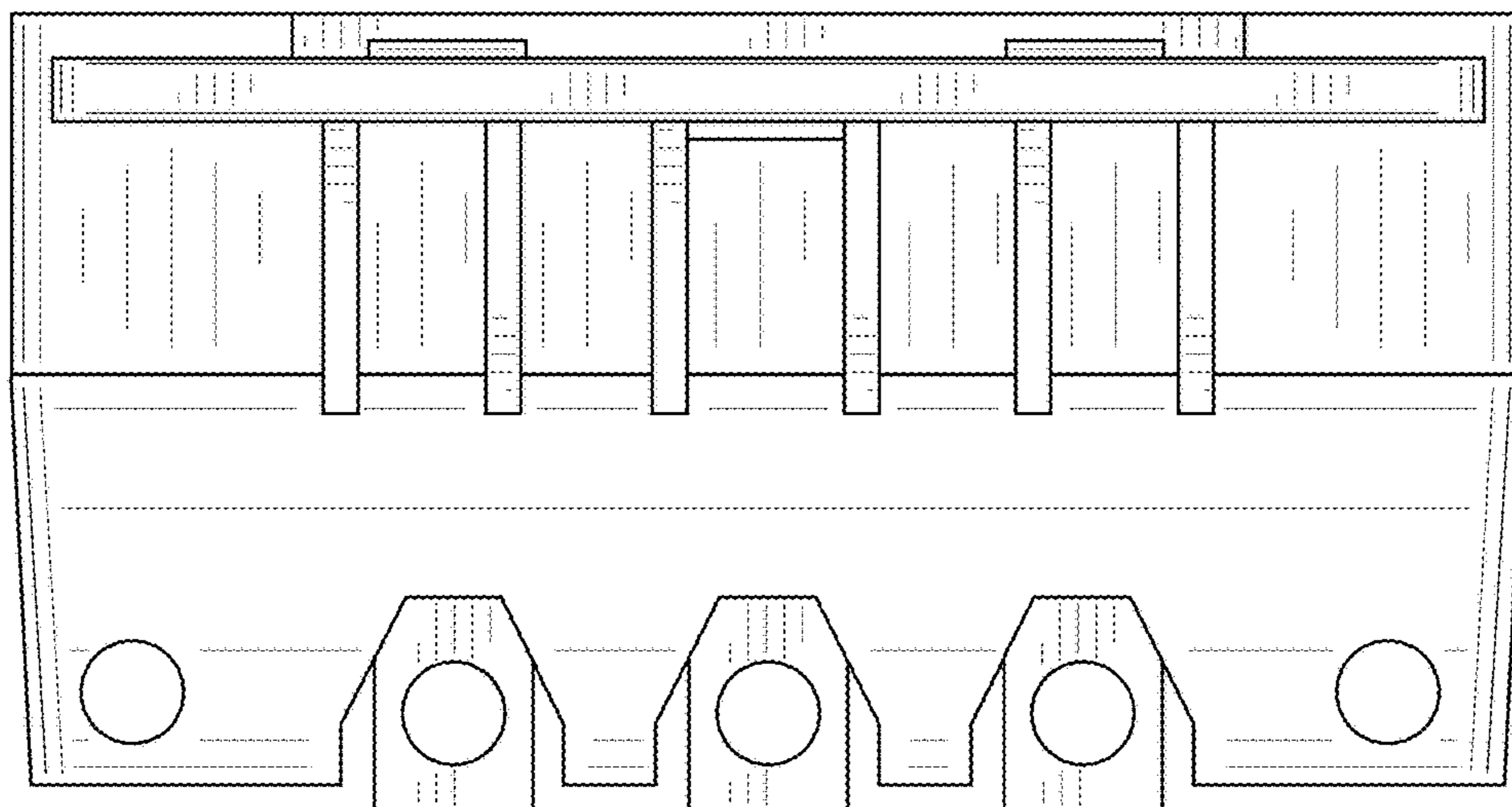
**FIG. 4**



**FIG. 5**



**FIG. 6**



**FIG. 7**